



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





# RF SWITCH CG2409X3

## High Power SPDT RF Switch

### DESCRIPTION

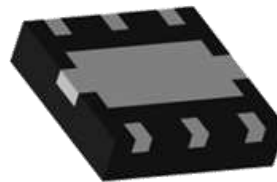
- The CG2409X3 is a GaAs MMIC high power SPDT (Single Pole Double Throw) switch which was designed for WiMAX and Wireless LAN applications

### FEATURES

- Control Voltage:  
VC(H) = 1.8 to 5.0 V (3.0V TYP.)  
VC(L) = -0.2 to 0.2 V (0V TYP.)
- Low Insertion Loss:  
 $L_{ins} = 0.40$  dB TYP. @  $f = 2.5$  GHz  
 $L_{ins} = 0.45$  dB TYP. @  $f = 3.8$  GHz  
 $L_{ins} = 0.55$  dB TYP. @  $f = 6.0$  GHz
- High Isolation:  
ISL = 31 dB TYP. @  $f = 2.5$  GHz  
ISL = 34 dB TYP. @  $f = 3.8$  GHz  
ISL = 34 dB TYP. @  $f = 6.0$  GHz
- Power Handling:  
 $P_{in}(0.1dB) = +37.5$  dBm TYP. @  $f = 0.4$  to 6.0 GHz,  
VC(H) = 3.0 V, VC(L) = 0 V

### PACKAGE

- 6-pin Thin SON Package (XS03)  
(1.5mm x 1.5mm x 0.37mm)



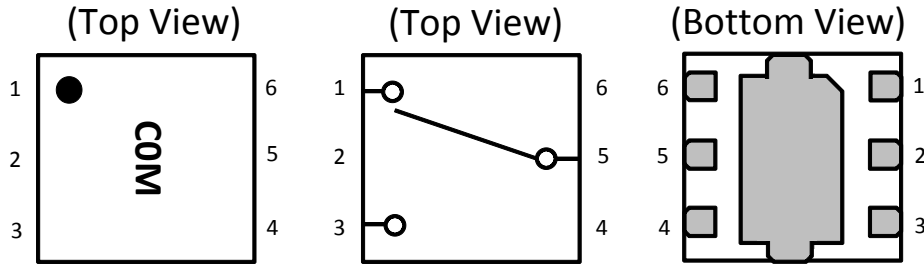
### APPLICATIONS

- WiMAX and wireless LAN  
(IEEE802.11a/b/g/n/ac)

### ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Description
CG2409X3	CG2409X3-C2	6-pin plastic TSON (Pb-Free)	C0M	<ul style="list-style-type: none"> <li>Embossed tape 8 mm wide</li> <li>Pin 1, 6 face the perforation side of the tape</li> <li>MOQ 10 kpcs/reel</li> </ul>
CG2409X3-EVAL	CG2409X3-EVAL			<ul style="list-style-type: none"> <li>Evaluation Board with DC block capacitors, power supply bypass capacitors, and RF and DC connectors</li> <li>MOQ 1</li> </ul>

## PIN CONFIGURATION AND INTERNAL BLOCK DIAGRAM



Pin No.	Pin Name
1	RF1
2	GND
3	RF2
4	VC2
5	RFC
6	VC1

**Remark** Exposed pad : GND

## TRUTH TABLE

VC1	VC2	RFC-RF1	RFC-RF2
High	Low	ON	OFF
Low	High	OFF	ON

## ABSOLUTE MAXIMUM RATINGS

(TA = +25°C, unless otherwise specified)

Parameter	Symbol	Rating	Unit
Control Voltage	VC	6.0 <sup>Note 1</sup>	V
Input Power	Pin	+38.0 <sup>Note 2</sup>	dBm
Operating Ambient Temperature	T <sub>A</sub>	-45~+85	°C
Storage Temperature	T <sub>stg</sub>	-55~+150	°C

- Note**
1.  $|VC1 - VC2| \leq 6.0V$
  2.  $3.0V \leq |VC1 - VC2| \leq 5.0V, 0.4GHz \leq f \leq 6.0GHz$

## RECOMMENDED OPERATING RANGE

(TA = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency	f	0.05	-	6.0	GHz
Switch Control Voltage (H)	VC(H)	+1.8	+3.0	+5.0	V
Switch Control Voltage (L)	VC(L)	-0.2	0	+0.2	V

## ELECTRICAL CHARACTERISTICS

(TA=+25°C, VC(H)=3.0V, VC(L)=0V, Zo=50Ω, DC Block Capacitance=8pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss	Lins1	f = 0.05 to 0.5 GHz <sup>Note 1</sup>	-	0.35	0.55	dB
	Lins2	f = 0.5 to 1.0 GHz <sup>Note 2</sup>	-	0.35	0.55	dB
	Lins3	f = 1.0 to 2.0 GHz <sup>Note 2</sup>	-	0.40	0.60	dB
	Lins4	f = 2.0 to 2.5 GHz	-	0.40	0.60	dB
	Lins5	f = 2.5 to 3.0 GHz	-	0.40	0.60	dB
	Lins6	f = 3.0 to 3.8 GHz	-	0.45	0.70	dB
	Lins7	f = 3.8 to 6.0 GHz	-	0.55	0.85	dB
Isolation	ISL1	f = 0.05 to 0.5 GHz <sup>Note 1</sup>	32	35	-	dB
	ISL2	f = 0.5 to 1.0 GHz <sup>Note 2</sup>	29	32	-	dB
	ISL3	f = 1.0 to 2.0 GHz <sup>Note 2</sup>	27	30	-	dB
	ISL4	f = 2.0 to 2.5 GHz	28	31	-	dB
	ISL5	f = 2.5 to 3.0 GHz	29	32	-	dB
	ISL6	f = 3.0 to 3.8 GHz	29	32	-	dB
	ISL7	f = 3.8 to 6.0 GHz	31	34	-	dB
Return Loss	RL1	f = 0.05 to 0.5 GHz <sup>Note 1</sup>	15	20	-	dB
	RL2	f = 0.5 to 2.0 GHz <sup>Note 2</sup>	15	20	-	dB
	RL3	f = 2.0 to 3.8 GHz	15	20	-	dB
	RL4	f = 3.8 to 6.0 GHz	15	20	-	dB
0.1 dB Loss Compression Input Power <sup>Note 3</sup>	P <sub>in(0.1dB)</sub>	f = 0.4 to 6.0 GHz	-	+37.5	-	dBm
2nd Harmonics	2f <sub>0</sub>	f = 2.5 GHz, P <sub>in</sub> =+26dBm	-	80	-	dBc
3rd Harmonics	3f <sub>0</sub>	f = 2.5 GHz, P <sub>in</sub> =+26dBm	-	85	-	dBc
Input 3rd Order Intercept Point	IIP3	f = 2.5 GHz 2-tone 1MHz Spacing	-	+62	-	dBm
Switch Control Speed	tsw	50% CTL to 90/10% RF	-	100	-	ns
Switch Control Current	I <sub>cont</sub>	Non RF	-	7	-	μA

**Note 1** DC block capacitance = 1,000pF at f=0.05 to 0.5 GHz

**Note 2** DC block capacitance = 56pF at f=0.4 to 2.0 GHz

**Note 3** P<sub>in(0.1dB)</sub> is the measured input power level when the insertion loss increases 0.1dB more than that of the linear range.





## RECOMMENDED SOLDERING CONDITIONS

Recommended Soldering Conditions are available on CEL's [Part Summary page](#) under Associated Documents

**REVISION HISTORY**

Version	Change to current version	Page(s)
CDS-0031-01 (Issue A) September 14, 2016	Preliminary datasheet	N/A
CDS-0031-02 (Issue B) December 27, 2016	Revised Electrical Characteristics table Added "Recommended Soldering Conditions" section	3, 5
CDS-0031-03 (Issue A) March 13, 2016	Initial Datasheet Revised Electrical Characteristics table	3

## [CAUTION]

- All information included in this document is current as of the date this document is issued. Such information, however, is subject to change without any prior notice.
- You should not alter, modify, copy, or otherwise misappropriate any CEL product, whether in whole or in part.
- CEL does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of CEL products or technical information described in this document. No license, expressed, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of CEL or others.
- Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. CEL assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
- CEL has used reasonable care in preparing the information included in this document, but CEL does not warrant that such information is error free. CEL assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.
- Although CEL endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a CEL product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures  
Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or system manufactured by you.
- Please use CEL products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive.  
CEL assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
- This document may not be reproduced or duplicated, in any form, in whole or in part, without prior written consent of CEL.
- Please contact CEL if you have any questions regarding the information contained in this document or CEL products, or if you have any other inquiries.



**[CAUTION]**

This product uses gallium arsenide (GaAs) of the toxic substance appointed in laws and ordinances. GaAs vapor and powder are hazardous to human health if inhaled or ingested.

- Do not dispose in fire or break up this product.
- Do not chemically make gas or powder with this product.
- When discarding this product, please obey the laws of your country.
- Do not lick the product or in any way allow it to enter the mouth.

**[CAUTION]**

Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

**CEL Headquarters** • 4590 Patrick Henry Drive • Santa Clara, CA 95054 • Tel: (408) 919-2500 • [www.cel.com](http://www.cel.com)

For a complete list of sales offices, representatives and distributors,

Please visit our website: [www.cel.com/contactus](http://www.cel.com/contactus)

For inquiries email us at [rhw@cel.com](mailto:rhw@cel.com)